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PATENT NUMBER and ISSUE DATE

U.S. **UTILITY** Patent Application

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ITLE : Ceramio lectrostatic clai	c substrate for sem mpless holder, and	iconduct substrat	or manufacture e for wafer pro	e/inspe ber	ction ap	paratus, cei	amic heate	г,
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<i>.</i>	1:	Assistant Examiner	Total Claims		Print Claim for O.G			
ISSUE FEE			DRAWING					
Amount Due	Date Paid	1	Sheets Drwg.	Figs.Drwg.	Print Fig:			
		Primary Examiner						
TERMINAL		PREPARED FOR ISSUE	Application Examiner					
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